



RECOMMENDED LAND PATTERN DIMENSION OF PCB
(RECOMMENDED METAL MASK THICKNESS: 0.15mm)

- NOTES
- 12 HATCHED PARTS: GROUND CIRCUIT.
 - SMT LEAD-COPLANARITY: 0.1 MAX.
 - THIS PRODUCT HAS NO POLARITY TO PATTERN FOR MOUNTING.
 - MAKE SURE WIDTH OF PATTERN IS WITHIN THAT OF LAND, OR LEAD MAY TOUCH PATTERN. (THIS APPLIES TO HATCHED AREA.)
 - DO NOT MOUNT OTHER DEVICES ONTO AREA, OR MATING PAIR CANNOT BE MATED.
 - THE DIMENSIONS IN PARENTHESES ARE FOR REFERENCE.

3, 4	PHOSPHOR BRONZE	TIN PLATING	2	COPPER ALLOY	CONTACT AREA : GOLD 0.1μm min. LEAD AREA : GOLD 0.05μm min. UNDER PLATING : NICKEL 1μm min.		
1	LCP	BEIGE UL94V-0					
NO.	MATERIAL	FINISH, REMARKS	NO.	MATERIAL	FINISH, REMARKS		
UNITS		SCALE	COUNT	DESCRIPTION OF REVISIONS	DESIGNED	CHECKED	DATE
mm		5 : 1					
HRS HIROSE ELECTRIC CO., LTD.		APPROVED : HS. OKAWA	11.05.18	DRAWING NO. EDC3-152095-25			
		CHECKED : HT. YAMAGUCHI	11.05.18	PART NO. FX11LA-120P/12-SV(71)			
		DESIGNED : SY. KAMIGA	11.05.18	CODE NO. CL573-0005-5-71			
		DRAWN : HK. SUNADORI	11.05.18				